



Dual P-Channel 1.8 V (G-S) MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------|------------------------------------|--------------------|-----------------------|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) | Q _g (Typ.) | |
| | 0.110 at V _{GS} = - 4.5 V | - 3.6 | | |
| - 20 | 0.160 at V _{GS} = - 2.5 V | - 3.0 | 5.1 | |
| | 0.240 at V _{GS} = - 1.8 V | - 2.4 | | |

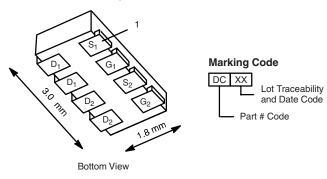
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFETs: 1.8 V Rated
- · Compliant to RoHS Directive 2002/95/EC



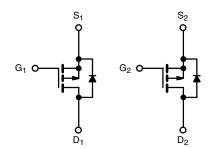


1206-8 ChipFET®



Ordering Information: Si5933DC-T1-E3 (Lead (Pb)-free)

Si5933DC-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

P-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted | | | | | | |
|---|------------------------|-----------------------------------|-------------|--------------|----------|--|
| Parameter | | Symbol | 5 s | Steady State | Unit | |
| Drain-Source Voltage | | V _{DS} | - 20 | | V | |
| Gate-Source Voltage | | V _{GS} | ± 8 | | v | |
| Continuous Drain Current (T, I = 150 °C) ^a | T _A = 25 °C | - I _D | - 3.6 | - 2.7 | | |
| Continuous Diam Current (1) = 150 C) | T _A = 85 °C | | - 2.6 | - 1.9 | Α | |
| Pulsed Drain Current | | I _{DM} | - 10 | | A | |
| Continuous Source Current (Diode Conduction) ^a | | I _S | - 1.8 | - 0.9 | | |
| Maximum Power Dissipation ^a | T _A = 25 °C | P _D | 2.1 | 1.1 | W | |
| Maximum Fower Dissipation | T _A = 85 °C | | 1.1 | 0.6 | VV | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | | °C | |
| Soldering Recommendations (Peak Temperature) ^{b, c} | | | 260 | | | |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Maximum Junction-to-Ambient ^a | t ≤ 5 s | R _{thJA} | 50 | 60 | °C/W |
| Maximum Junction-to-Ambient | Steady State | | 90 | 110 | |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 30 | 40 | |

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. See reliability manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

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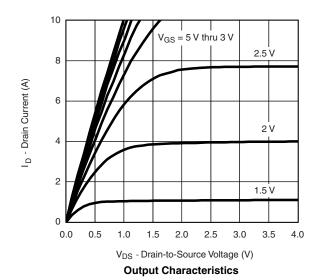
| SPECIFICATIONS T _J = 25 °C, unless otherwise noted | | | | | | | |
|--|---------------------|---|--------|-------|-------|------|--|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
| Static | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ | - 0.45 | | - 1.0 | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$ | | | ± 100 | nA | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = - 20 V, V _{GS} = 0 V | | | - 1 | μА | |
| | | $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$ | | | - 5 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$ | - 10 | | | Α | |
| Drain-Source On-State Resistance ^a | | $V_{GS} = -4.5 \text{ V}, I_D = -2.7 \text{ A}$ | | 0.095 | 0.110 | | |
| | R _{DS(on)} | V _{GS} = - 2.5 V, I _D = - 2.2 A | | 0.137 | 0.160 | Ω | |
| | | V _{GS} = - 1.8 V, I _D = - 1 A | | 0.205 | 0.240 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 10 V, I _D = - 2.7 A | | 7 | | S | |
| Diode Forward Voltage ^a | V_{SD} | I _S = - 0.9 A, V _{GS} = 0 V | | - 0.8 | - 1.2 | V | |
| Dynamic ^b | | | | | | | |
| Total Gate Charge | Qg | | | 5.1 | 7.7 | | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -2.7 \text{ A}$ | | 1.2 | | nC | |
| Gate-Drain Charge | Q_{gd} | | | 1.0 | | | |
| Turn-On Delay Time | t _{d(on)} | | | 16 | 25 | | |
| Rise Time | t _r | $ \begin{array}{c c} t_r & V_{DD} = \text{- 10 V, R}_L = \text{10 } \Omega \\ \hline t_{d(off)} & I_D \cong \text{- 1 A, V}_{GEN} = \text{- 4.5 V, R}_g = \text{6 } \Omega \\ \end{array} $ | | 30 | 45 | ns | |
| Turn-Off Delay Time | t _{d(off)} | | | 30 | 45 | | |
| Fall Time | t _f | | | 27 | 40 | | |
| Source-Drain Reverse Recovery Time | t _{rr} | I _F = - 0.9 A, dl/dt = 100 A/μs | | 20 | 40 | | |

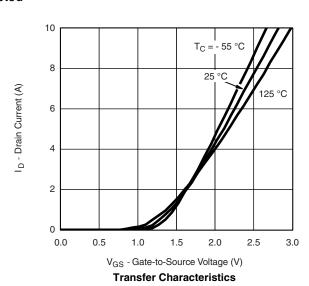
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

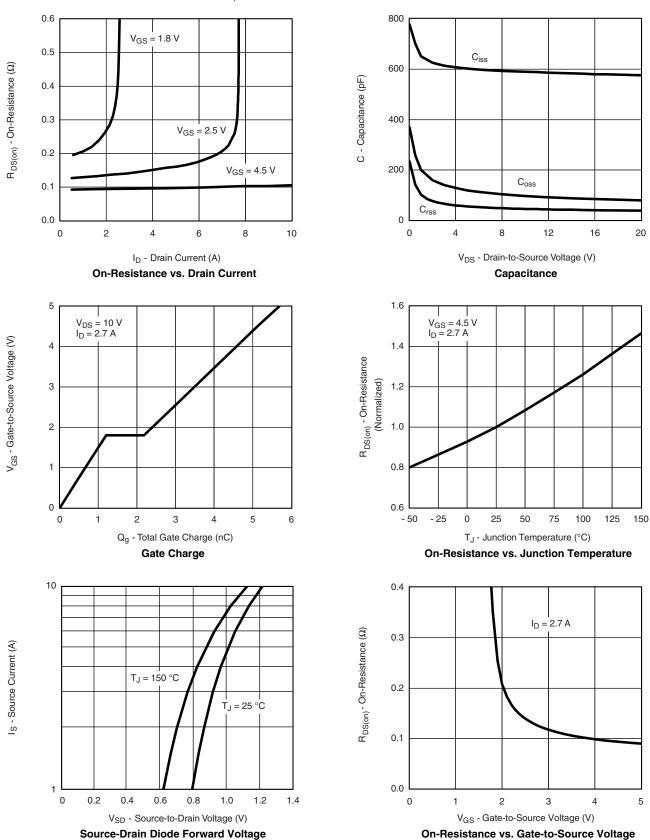








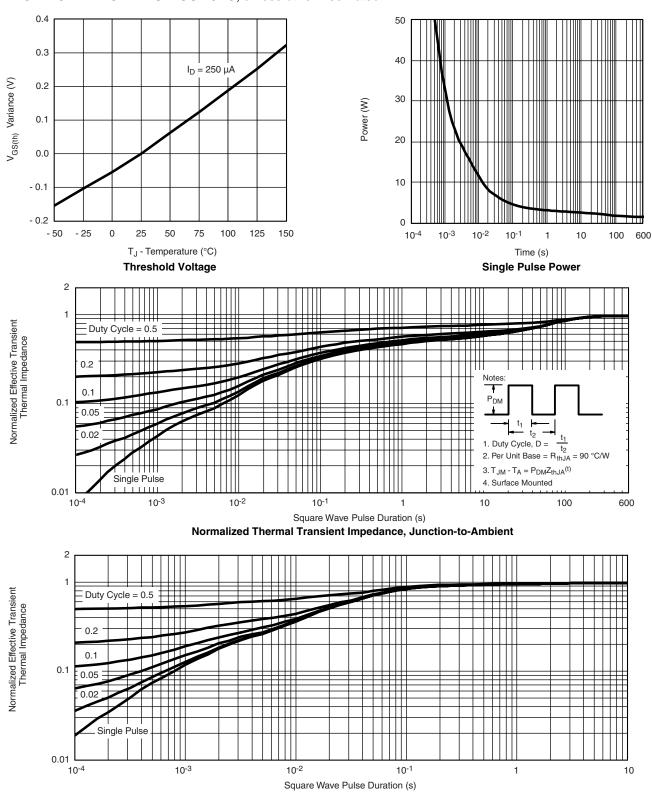
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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